

TOWARDS A STRAW MAN

Marco Gersabeck (CERN) VELO Upgrade Meeting, 28/04/10





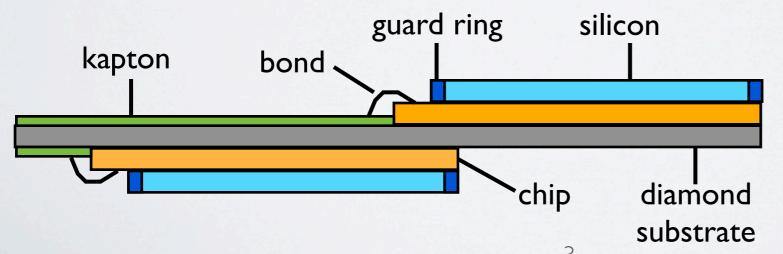


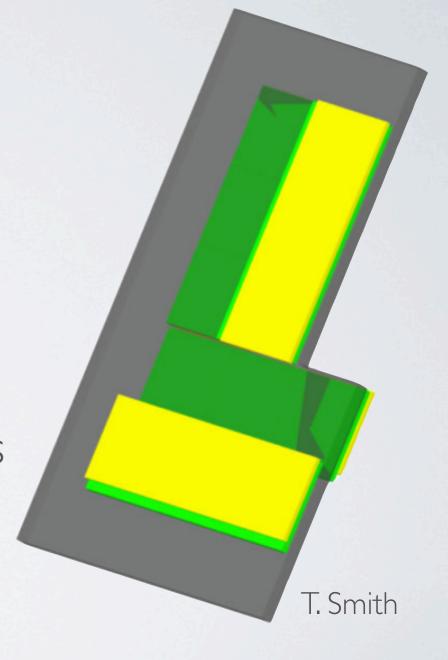
INTRO

- Follow-up of my talk from two weeks ago (and the slides on last week's agenda)
- Try to define straw man layout today

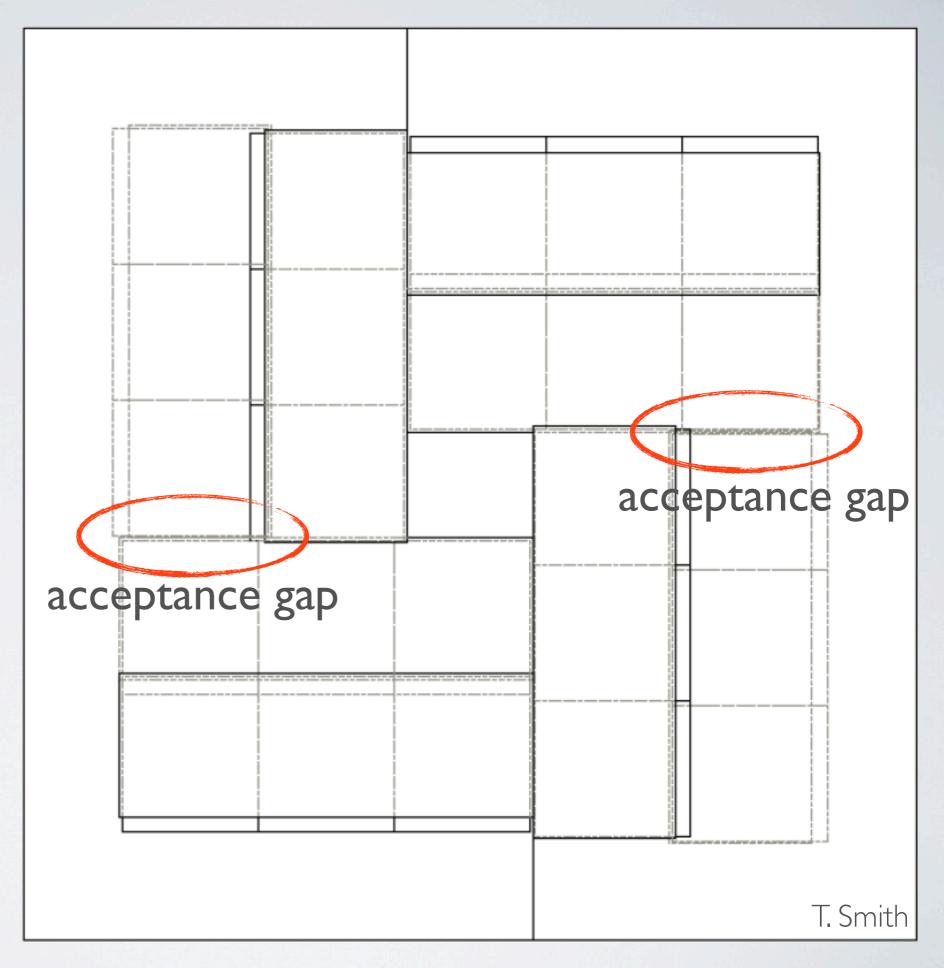
PSEUDO DOUBLE SIDED

- Avoid bi-metallic effects by splitting 6 chip unit in two rows of 3 chips mounted on either side of the substrate
- No requirement for TSVs
- Reduced risk in assembly but now 2-sided
- 2 options: 3 chip unit or 3 individual pieces





Only two gaps in acceptance in x-y projection



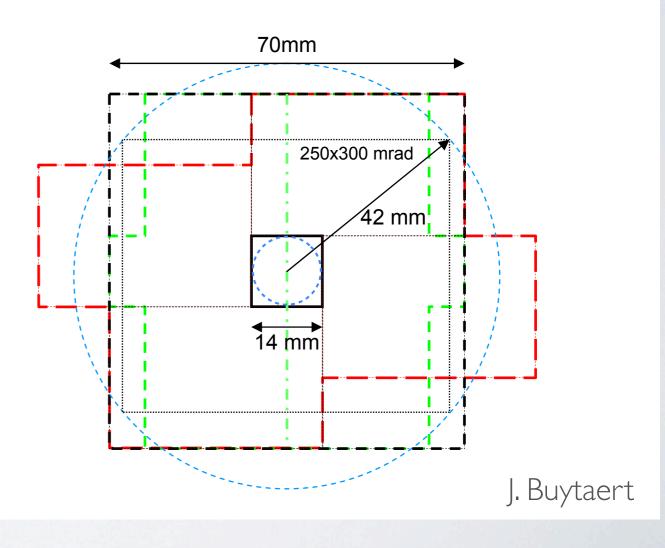
SOME NUMBERS

- Assume 3 chip units with common guard ring
- · Overlap such that active area is gap-less in x-y projection
- Guard ring: 500 um
- Single chip: 14.1 mm x 14.1+1 mm, I for readout pads
- Thicknesses: substrate 200 um, chip 150 um, silicon 150 um, glue 50 um?

ZDISTRIBUTION

- Different coverage in x-y leads to different acceptance
- Adapt by changing z distribution
- 25 station layout optimised for U-shape exists with minimum pitch of 24 mm
- Simulated by Steve Blusk for L-shape

L-shaped 1 L-shaped 2 U-shaped VELO sensor



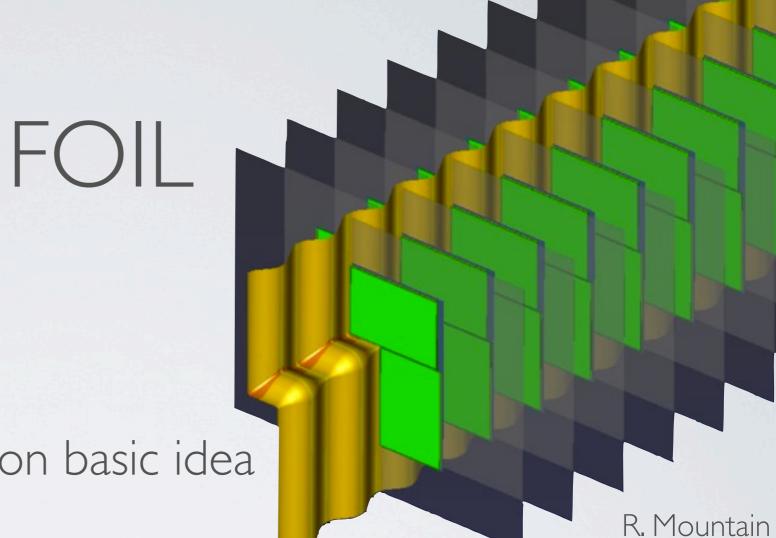
ZDISTRIBUTION

Suggested layout for 24 mm spacing

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z_pix_A = [-117., -93., -69., -45., -21., 3., 27., 51., 75., 99., 123., 147., 171., 195., 240., 310., 385., 470., 600., 650., 700., 750.]
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 $z_pix_C = [-102., -81., -57., -33., -9., 15., 39., 63., 87., 111., 135., 159., 183., 207., 252., 298., 373., 458., 588., 638., 688., 738.]$

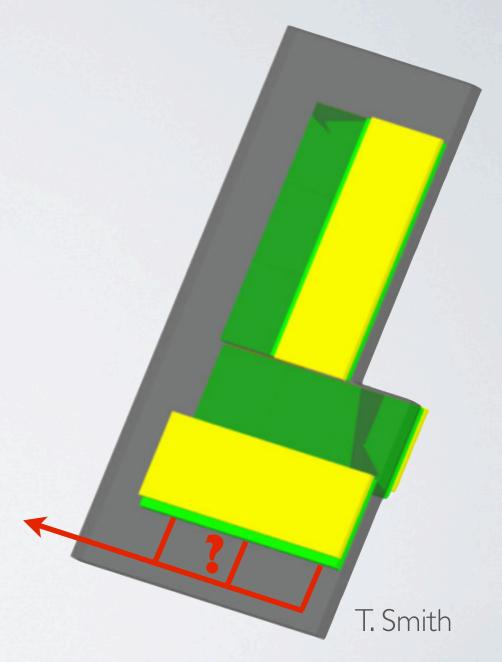
- Questions:
- Impact of additional material?
 Probably roughly balanced by smaller corrugations



- Rather broad agreement on basic idea
- Needs to be defined in more detail
- May need to adjust to different z-distribution
- WP 10 organised by Ray Mountain

COOLING & READOUT

- Where to put the cooling?
- How to combine efficiently cooling and signal routing?
- How to accommodate 90° turn in readout of side pieces?
- Input from relevant WP needed



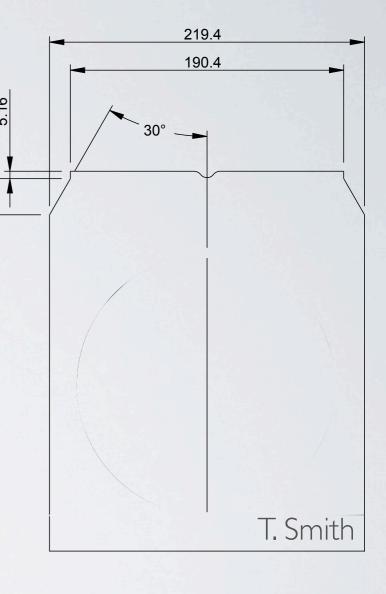
READOUT

Info from Tony:

More space available than with current VELO:
 190-220 mm rather than 160 mm

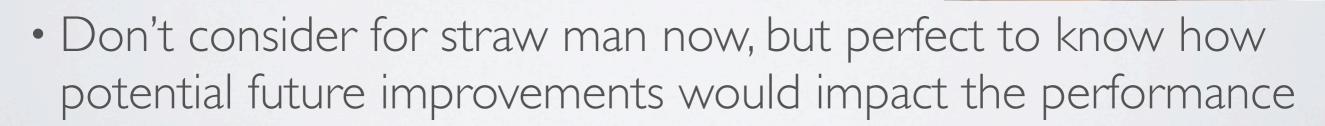
 Using the available space reduces issues with readout of "side" chips

 Large modules probably only possible with TPG hybrids



ALTERNATIVES

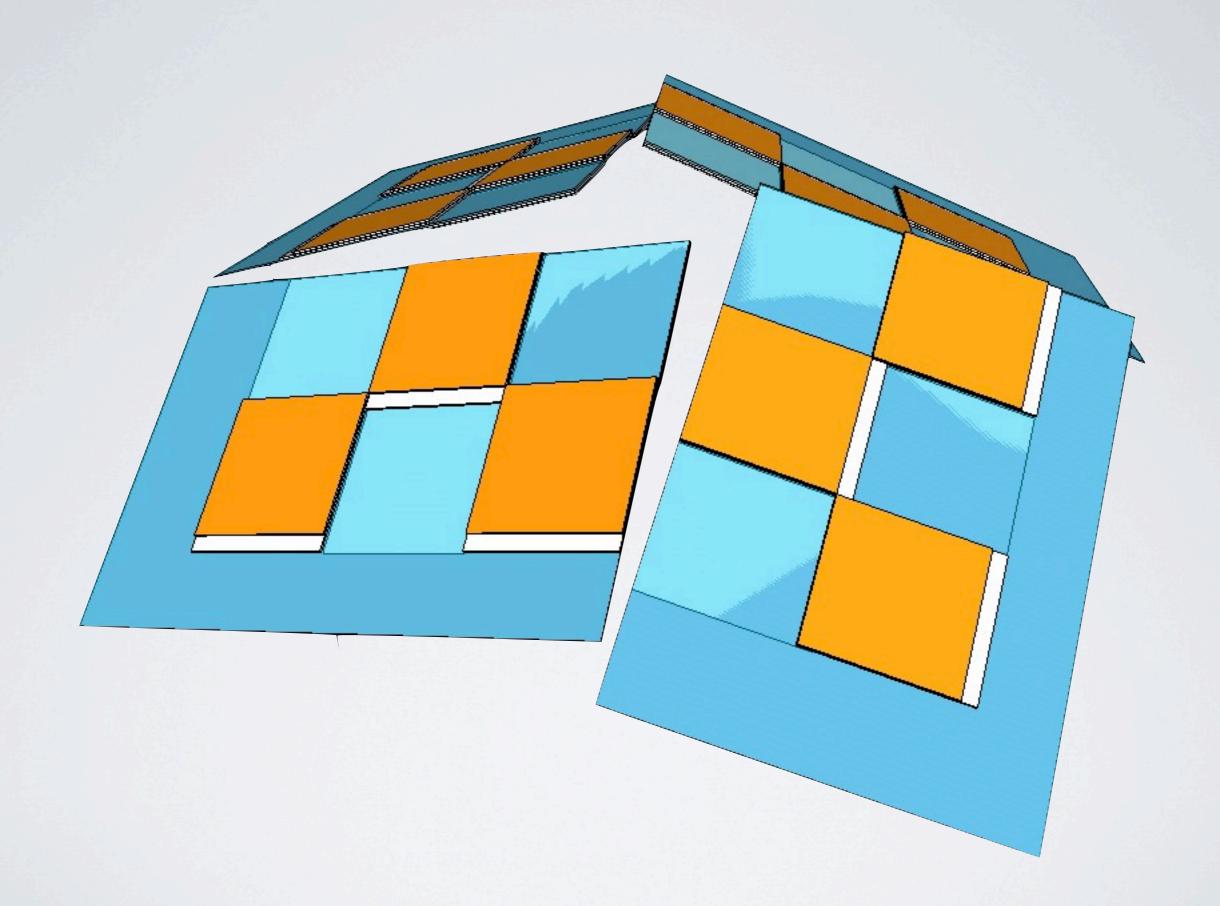
- Lots of alternatives studied by Steve Blusk (see his talk)
- Angled modules (the Angel of Amsterdam returns)
- Reduced guard ring width
- Reduced beam hole
- Floating pixels



Also: strip option (see Abraham's talk)



FASTEN YOUR SEATBELT!



TODO

- · Define cooling & readout structure for straw man design
- Documentation:
 - Twiki
 - LOI: main focus: layout defined here also: alternatives presented in the past and today including strip